



PRELIMINARY

CY2310ANZ

3.3V SDRAM Buffer for Mobile PCs with 4 SO-DIMMs

Features

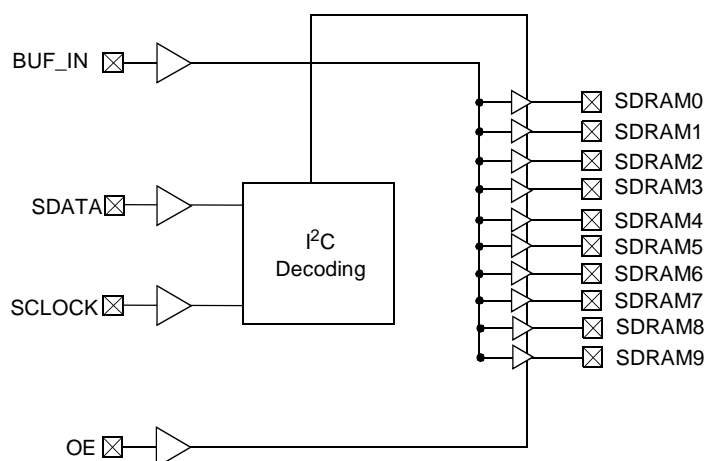
- One input to 10 output buffer/driver
- Supports up to four SDRAM SO-DIMMs
- Two additional outputs for feedback
- I²C™ interface for output control
- Low skew outputs
- Up to 100 MHz operation
- Multiple V_{DD} and V_{SS} pins for noise reduction
- Dedicated OE pin for testing
- Space-saving 28-pin SSOP package
- 3.3V operation

Functional Description

The CY2310ANZ is a 3.3V buffer designed to distribute high-speed clocks in mobile PC applications. The part has 10 outputs, 8 of which can be used to drive up to four SDRAM SO-DIMMs, and the remaining can be used for external feedback to a PLL. The device operates at 3.3V and outputs can run up to 100 MHz, thus making it compatible with Pentium II® processors. The CY2310ANZ can be used in conjunction with the CY2281 or similar clock synthesizer for a full Pentium II motherboard solution.

The CY2310ANZ also includes an I²C interface which can enable or disable each output clock. On power-up, all output clocks are enabled. A separate Output Enable pin facilitates testing on ATE.

Block Diagram



Pin Configuration

28-pin SSOP Top View

V _{DD}	1	28	V _{DD}
SDRAM0	2	27	SDRAM7
SDRAM1	3	26	SDRAM6
V _{SS}	4	25	V _{SS}
V _{DD}	5	24	V _{DD}
SDRAM2	6	23	SDRAM5
SDRAM3	7	22	SDRAM4
V _{SS}	8	21	V _{SS}
BUF_IN	9	20	OE
V _{DD}	10	19	V _{DD}
SDRAM8	11	18	SDRAM9
V _{SS}	12	17	V _{SS}
V _{DDIIC}	13	16	V _{SSIIC}
SDATA	14	15	SCLOCK

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Pin Summary

Name	Pins	Description
V _{DD}	1, 5, 10, 19, 24, 28	3.3V Digital voltage supply
V _{SS}	4, 8, 12, 17, 21, 25	Ground
V _{DDIIC}	13	I ² C Voltage supply
V _{SSIIC}	16	Ground for I ² C
BUF_IN	9	Input clock
OE	20	Output Enable, three-states outputs when LOW. Internal pull-up to V _{DD}
SDATA	14	I ² C data input, internal pull-up to V _{DD}
SCLK	15	I ² C clock input, internal pull-up to V _{DD}
SDRAM [0–3]	2, 3, 6, 7	SDRAM byte 0 clock outputs
SDRAM [4–7]	22, 23, 26, 27	SDRAM byte 1 clock outputs
SDRAM [8–9]	11, 18	SDRAM byte 2 clock outputs

Device Functionality

OE	SDRAM [0–17]
0	High-Z
1	1 x BUF_IN

Serial Configuration Map

- The Serial bits will be read by the clock driver in the following order:

Byte 0 - Bits 7, 6, 5, 4, 3, 2, 1, 0

Byte 1 - Bits 7, 6, 5, 4, 3, 2, 1, 0

.

Byte N - Bits 7, 6, 5, 4, 3, 2, 1, 0

- Reserved and unused bits should be programmed to “0”.
- I²C Address for the CY2310ANZ is:

A6	A5	A4	A3	A2	A1	A0	R/W
1	1	0	1	0	0	1	----

Byte 1: SDRAM Active/Inactive Register (1 = Active, 0 = Inactive), Default = Active

Bit	Pin #	Description
Bit 7	27	SDRAM7 (Active/Inactive)
Bit 6	26	SDRAM6 (Active/Inactive)
Bit 5	23	SDRAM5 (Active/Inactive)
Bit 4	22	SDRAM4 (Active/Inactive)
Bit 3	--	Initialize to 0
Bit 2	--	Initialize to 0
Bit 1	--	Initialize to 0
Bit 0	--	Initialize to 0

Byte 0:SDRAM Active/Inactive Register (1 = Enable, 0 = Disable), Default = Enabled

Bit	Pin #	Description
Bit 7	--	Initialize to 0
Bit 6	--	Initialize to 0
Bit 5	--	Initialize to 0
Bit 4	--	Initialize to 0
Bit 3	7	SDRAM3 (Active/Inactive)
Bit 2	6	SDRAM2 (Active/Inactive)
Bit 1	3	SDRAM1 (Active/Inactive)
Bit 0	2	SDRAM0 (Active/Inactive)

Byte 2: SDRAM Active/Inactive Register (1 = Active, 0 = Inactive), Default = Active

Bit	Pin #	Description
Bit 7	18	SDRAM9 (Active/Inactive)
Bit 6	11	SDRAM8 (Active/Inactive)
Bit 5	--	Reserved, drive to 0
Bit 4	--	Reserved, drive to 0
Bit 3	--	Reserved, drive to 0
Bit 2	--	Reserved, drive to 0
Bit 1	--	Reserved, drive to 0
Bit 0	--	Reserved, drive to 0

Maximum Ratings

Supply Voltage to Ground Potential..... -0.5V to +7.0V
 DC Input Voltage (Except BUF_IN) -0.5V to $V_{DD} + 0.5V$
 DC Input Voltage (BUF_IN) -0.5V to +7.0V
 Storage Temperature -65°C to +150°C

Max. Soldering Temperature (10 sec.) 260°C
 Junction Temperature 150°C
 Static Discharge Voltage
 (per MIL-STD-883, Method 3015) >2000V

Operating Conditions

Parameter	Description	Min.	Max.	Unit
V_{DD}	Supply Voltage	3.135	3.465	V
T_A	Operating Temperature (Ambient Temperature)	0	70	°C
C_L	Load Capacitance	20	30	pF
C_{IN}	Input Capacitance		7	pF

Electrical Characteristics

Parameter	Description	Test Conditions	Min.	Max.	Unit
V_{IL}	Input LOW Voltage ^[1]	Except I ² C pins		0.8	V
V_{ILiic}	Input LOW Voltage	For I ² C pins only		0.7	V
V_{IH}	Input HIGH Voltage ^[1]		2.0		V
I_{IL}	Input LOW Current (BUF_IN input)	$V_{IN} = 0V$	-10	10	μA
I_{IL}	Input LOW Current (Except BUF_IN Pin)	$V_{IN} = 0V$		100	μA
I_{IH}	Input HIGH Current	$V_{IN} = V_{DD}$	-10	10	μA
V_{OL}	Output LOW Voltage ^[2]	$I_{OL} = 25\text{ mA}$		0.4	V
V_{OH}	Output HIGH Voltage ^[2]	$I_{OH} = -36\text{ mA}$	2.4		V
I_{DD}	Supply Current ^[2]	Unloaded outputs, 100 MHz		200	mA
I_{DD}	Supply Current	Loaded outputs, 100 MHz		360	mA
I_{DD}	Supply Current ^[2]	Unloaded outputs, 66.67 MHz		150	mA
I_{DD}	Supply Current	Loaded outputs, 66.67 MHz		230	mA
I_{DDs}	Supply Current	BUF_IN= V_{DD} or V_{SS} All other inputs at V_{DD}		500	μA

Notes:

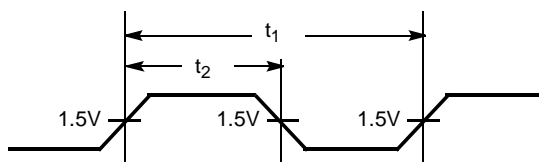
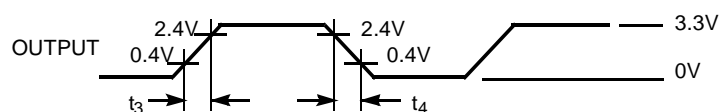
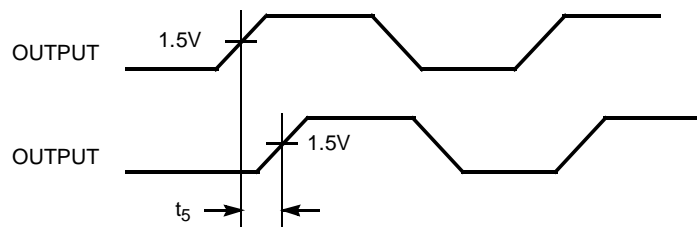
1. BUF_IN input has a threshold voltage of $V_{DD}/2$.
2. Parameter is guaranteed by design and characterization. Not 100% tested in production.

Switching Characteristics^[3]

Parameter	Name	Test Conditions	Min.	Typ.	Max.	Unit
	Maximum Operating Frequency				100	MHz
	Duty Cycle ^[2,4] = $t_2 \div t_1$	Measured at 1.5V	45.0	50.0	55.0	%
t_3	Rising Edge Rate ^[2]	Measured between 0.4V and 2.4V	0.9	1.5	4.0	V/ns
t_4	Falling Edge Rate ^[2]	Measured between 2.4V and 0.4V	0.9	1.5	4.0	V/ns
t_5	Output to Output Skew ^[2]	All outputs equally loaded		150	250	ps
t_6	SDRAM Buffer LH Prop. Delay ^[2]	Input edge greater than 1V/ns	1.0	3.5	5.0	ns
t_7	SDRAM Buffer HL Prop. Delay ^[2]	Input edge greater than 1V/ns	1.0	3.5	5.0	ns
t_8	SDRAM Buffer Enable Delay ^[2]	Input edge greater than 1V/ns	1.0	5	12	ns
t_9	SDRAM Buffer Disable Delay ^[2]	Input edge greater than 1V/ns	1.0	20	30	ns

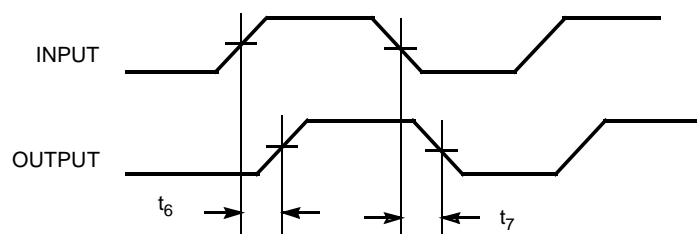
Notes:

3. All parameters specified with loaded outputs.
4. Duty cycle of input clock is 50%. Rising and falling edge rate is greater than 1V/ns

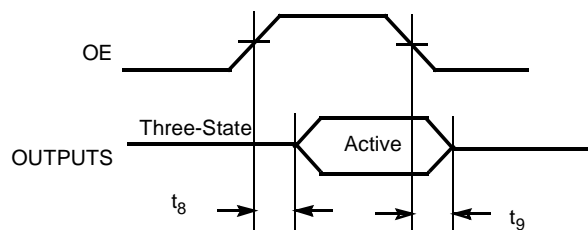
Switching Waveforms
Duty Cycle Timing

All Outputs Rise/Fall Time

Output-Output Skew


Switching Waveforms (continued)

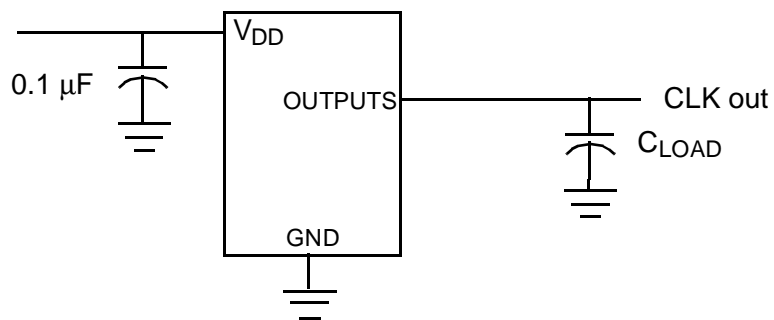
SDRAM Buffer LH and HL Propagation Delay



SDRAM Buffer Enable and Disable Times



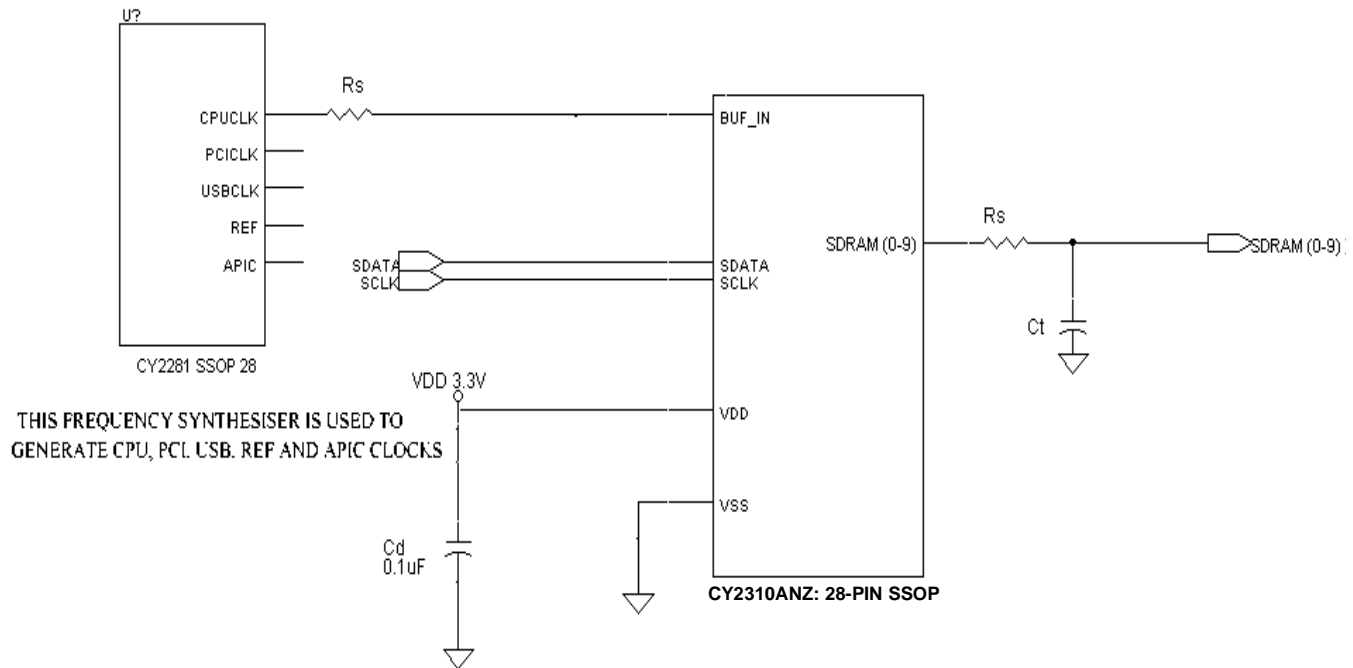
Test Circuit



Application Information

Clock traces must be terminated with either series or parallel termination, as they are normally done.

Application Circuit



C_d = DECOUPLING CAPACITOR

C_t = OPTIONAL EMI-REDUCING CAPACITORS

R_s = SERIES TERMINATING RESISTORS

Summary

- Surface mount, low-ESR, ceramic capacitors should be used for filtering. Typically, these capacitors have a value of 0.1 μ F. In some cases, smaller value capacitors may be required.
- The value of the series terminating resistor satisfies the following equation, where R_{trace} is the loaded characteristic impedance of the trace, R_{out} is the output impedance of the buffer (typically 25 Ω), and R_{series} is the series terminating resistor.

$$R_{series} > R_{trace} - R_{out}$$
- Footprints must be laid out for optional EMI-reducing capacitors, which should be placed as close to the terminating resistor as is physically possible. Typical values of these capacitors range from 4.7 pF to 22 pF.
- A Ferrite Bead **may** be used to isolate the Board V_{DD} from the clock generator V_{DD} island. Ensure that the Ferrite Bead offers greater than 50 Ω impedance at the clock frequency, under loaded DC conditions. Please refer to the application note "Layout and Termination Techniques for Cypress Clock Generators" for more details.
- If a Ferrite Bead is used, a 10 μ F–22 μ F tantalum bypass capacitor should be placed close to the Ferrite Bead. This capacitor prevents power supply droop during current surges.

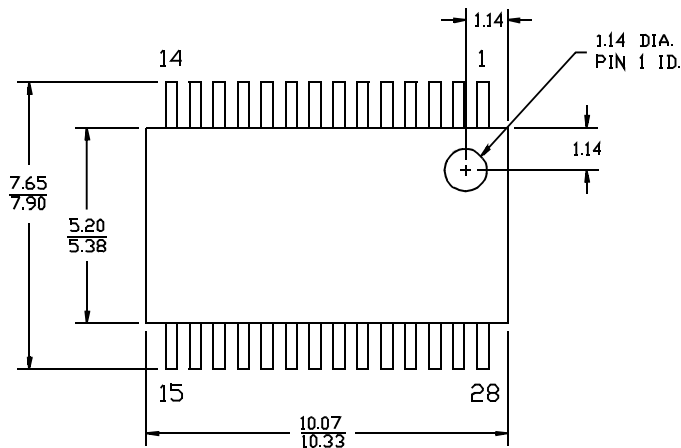
Ordering Information

Ordering Code	Package Name	Package Type	Operating Range
CY2310ANZPVC-1	O28	28-pin SSOP	Commercial

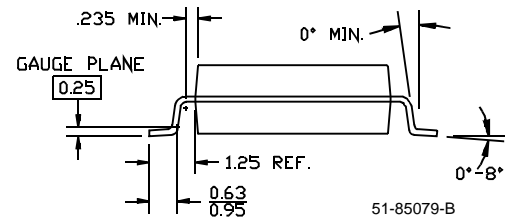
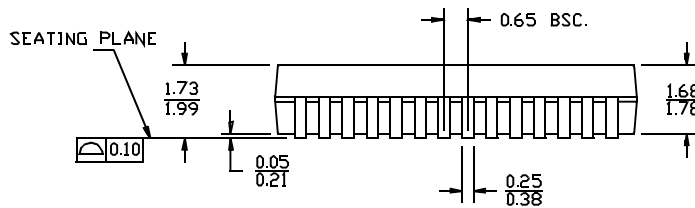
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Package Diagram

28-Lead (210-Mil) Shrunk Small Outline Package O28



DIMENSIONS IN MILLIMETERS MIN. MAX.



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